Taiwan Semiconductor

2A, 200V - 1000V Standard Surface Mount Rectifier

FEATURES

TAIWAN

• Glass passivated chip junction

SEMICONDUCTOR

- Ideal for automated placeme
- Moisture sensitivity level: level 1, per J-STD-020
- RoHS Compliant
- Halogen-free according to IEC 61249-2-21

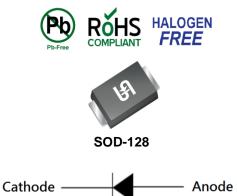
APPLICATIONS

- DC to DC converter
- Switching mode converters and inverters
- General purpose

MECHANICAL DATA

- Case: SOD-128
- Molding compound meets UL 94V-0 flammability rating
- Terminal: Matte tin plated leads, solderable per J-STD-002
- Meet JESD 201 class 2 whisker test
- Polarity: Indicated by cathode band
- Weight: 0.027g (approximately)

| KEY PARAMETERS | | | | |
|--------------------|------------|------|--|--|
| PARAMETER | VALUE | UNIT | | |
| I _F | 2 | А | | |
| V _{RRM} | 200 - 1000 | V | | |
| I _{FSM} | 50 | А | | |
| T _{J MAX} | 150 | °C | | |
| Package | SOD-128 | | | |
| Configuration | Single die | | | |



| ABSOLUTE MAXIMUM RATINGS (T _A = 25°C unless otherwise noted) | | | | | | | | |
|---|-----------|---------------------|-------------|-------|-------|-------|-------|------|
| PARAMETER | | SYMBOL | S2DFS | S2GFS | S2JFS | S2KFS | S2MFS | UNIT |
| Marking code on the device | | | S2DFS | S2GFS | S2JFS | S2KFS | S2MFS | |
| Repetitive peak reverse voltag | е | V _{RRM} | 200 | 400 | 600 | 800 | 1000 | V |
| Reverse voltage, total rms valu | le | V _{R(RMS)} | 140 | 280 | 420 | 560 | 700 | V |
| Forward current | | I _F | | | 2 | | | А |
| Surge peak forward current, single half sine-wave | t = 8.3ms | | | | 50 | | | А |
| superimposed on rated load t = 1.0ms | | I _{FSM} | | | 140 | | | А |
| Junction temperature | | TJ | -55 to +150 | | | | °C | |
| Storage temperature | | T _{STG} | -55 to +150 | | | °C | | |



| THERMAL PERFORMANCE | | | | |
|--|------------------|-----|------|--|
| PARAMETER | SYMBOL | ТҮР | UNIT | |
| Junction-to-lead thermal resistance | R _{θJL} | 14 | °C/W | |
| Junction-to-ambient thermal resistance | R _{eJA} | 74 | °C/W | |
| Junction-to-case thermal resistance | R _{eJC} | 20 | °C/W | |

Thermal Performance Note: Units mounted on PCB (5mm x 5mm Cu pad test board)

| ELECTRICAL SPECIFICATIONS (T _A = 25°C unless otherwise noted) | | | | | |
|--|--------------------------------|------------------|------|--------|------|
| PARAMETER | CONDITIONS | SYMBOL | ТҮР | MAX | UNIT |
| | $I_F = 1A, T_J = 25^{\circ}C$ | | 0.91 | 0.91 - | V |
| Forward voltage ⁽¹⁾ | $I_F = 2A, T_J = 25^{\circ}C$ | V _F | 0.98 | 1.10 | V |
| | $I_F = 1A, T_J = 125^{\circ}C$ | | 0.79 | - | V |
| | $I_F = 2A, T_J = 125^{\circ}C$ | | 0.88 | 0.98 | V |
| Reverse current @ rated $V_R^{(2)}$ | $T_J = 25^{\circ}C$ | I | - | 1 | μA |
| | T _J = 125°C | - I _R | - | 33 | μA |
| Junction capacitance | 1MHz, $V_{R} = 4.0V$ | CJ | 12 | - | pF |

Notes:

- 1. Pulse test with PW = 0.3ms
- 2. Pulse test with PW = 30ms

ORDERING INFORMATION

| ORDERING CODE ⁽¹⁾ | PACKAGE | PACKING |
|------------------------------|---------|----------------------|
| S2xFS | SOD-128 | 14,000 / Tape & Reel |

Notes:

1. "x" defines voltage from 200V(S2DFS) to 1000V(S2MFS)



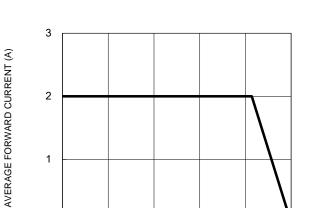
0

25

50

CHARACTERISTICS CURVES

(T_A = 25°C unless otherwise noted)



75

LEAD TEMPERATURE (°C)

Fig.3 Typical Reverse Characteristics

100

125

150

Fig.1 Forward Current Derating Curve

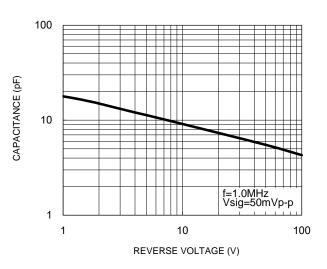
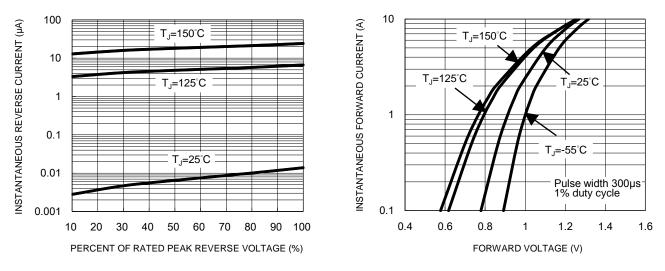
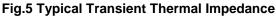
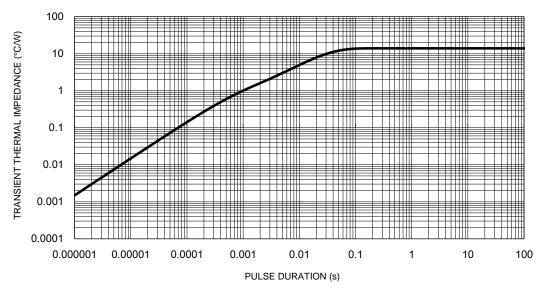


Fig.2 Typical Junction Capacitance





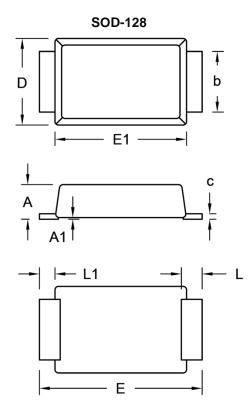




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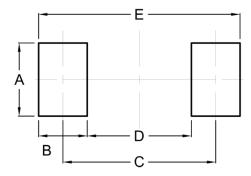


PACKAGE OUTLINE DIMENSIONS



| DIM. | Unit (mm) | | Unit | (inch) | |
|------|-----------|------|-------|--------|--|
| | Min. | Max. | Min. | Max. | |
| A | 0.90 | 1.10 | 0.035 | 0.043 | |
| A1 | 0.00 | 0.10 | 0.000 | 0.004 | |
| b | 1.60 | 1.90 | 0.063 | 0.075 | |
| с | 0.10 | 0.22 | 0.004 | 0.009 | |
| D | 2.30 | 2.70 | 0.091 | 0.106 | |
| E | 4.40 | 5.00 | 0.173 | 0.197 | |
| E1 | 3.60 | 4.00 | 0.142 | 0.157 | |
| L | 0.40 | 0.80 | 0.016 | 0.031 | |
| L1 | 0.30 | 0.60 | 0.012 | 0.024 | |

SUGGESTED PAD LAYOUT



| Symbol | Unit (mm) | Unit (inch) |
|--------|-----------|-------------|
| А | 2.10 | 0.083 |
| В | 1.40 | 0.055 |
| С | 4.40 | 0.173 |
| D | 3.00 | 0.118 |
| E | 5.80 | 0.228 |

MARKING DIAGRAM



P/N = Marking Code

YW = Date Code

F = Factory Code



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